74LVC1G98

Low-power configurable multiple function gate

Rev. 6 — 25 January 2022

Product data sheet

1. General description

The 74LVC1G98 is a configurable multiple function gate with Schmitt-trigger inputs. The device can be configured as any of the following logic functions MUX, AND, OR, NAND, NOR, inverter and buffer; using the 3-bit input. All inputs can be connected to V_{CC} or GND.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

This device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant input/output for interfacing with 5 V logic
- High noise immunity
- ±24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power dissipation
- I_{OFF} circuitry provides partial Power-down mode operation
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Latch-up performance exceeds 250 mA
 - Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- · ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

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3. Ordering information

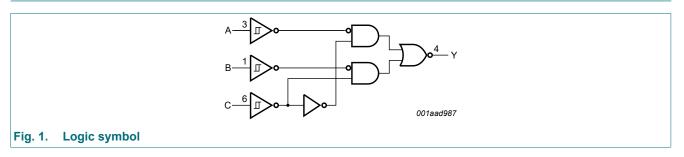
Type number	Package	Package							
	Temperature range	Name	Description	Version					
74LVC1G98GW	-40 °C to +125 °C	TSSOP6	plastic thin shrink small outline package; 6 leads; body width 1.25 mm	SOT363-2					
74LVC1G98GV	-40 °C to +125 °C	SC-74; TSOP6	plastic surface-mounted package; 6 leads	SOT457					
74LVC1G98GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886					
74LVC1G98GN	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm	SOT1115					
74LVC1G98GS	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm	SOT1202					

4. Marking

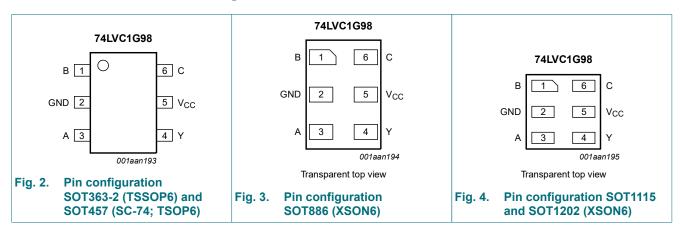
Table 2. Marking				
Type number	Marking code[1]			
74LVC1G98GW	V9			
74LVC1G98GV	V98			
74LVC1G98GM	V9			
74LVC1G98GN	V9			
74LVC1G98GS	V9			

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information



6.1. Pinning

6.2. Pin description

Table 3. Pin description						
Symbol	Pin	Description				
В	1	data input				
GND	2	ground (0 V)				
A	3	data input				
Y	4	data output				
V _{CC}	5	supply voltage				
С	6	data input				

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level.

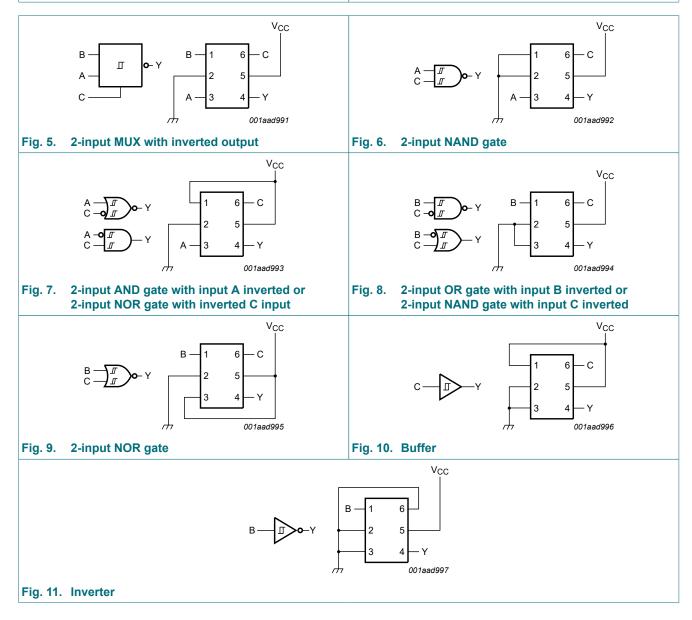
Input	Output		
C	В	Α	Y
L	L	L	Н
L	L	Н	Н
L	Н	L	L
L	Н	Н	L
Н	L	L	Н
Н	L	Н	L
Н	Н	L	Н
Н	Н	Н	L

74LVC1G98

7.1. Logic configurations

Table 5. Function selection table

Logic function	Figure
2-input MUX with inverted output	see <u>Fig. 5</u>
2-input NAND	see <u>Fig. 6</u>
2-input NOR with one input inverted	see Fig. 7
2-input AND with one input inverted	see <u>Fig. 7</u>
2-input NAND with one input inverted	see <u>Fig. 8</u>
2-input OR with one input inverted	see <u>Fig. 8</u>
2-input NOR	see <u>Fig. 9</u>
Buffer	see <u>Fig. 10</u>
Inverter	see <u>Fig. 11</u>



8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage	[1]	-0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	Active mode [1]	-0.5	+6.5	V
		Power-down mode; $V_{CC} = 0 V$ [1]	-0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C [2]	-	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT363-2 (TSSOP6) package: P_{tot} derates linearly with 3.7 mW/K above 83 °C.
 For SOT457 (SC-74; TSOP6) package: P_{tot} derates linearly with 4.1 mW/K above 89 °C.
 For SOT886 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
 For SOT1115 (XSON6) package: P_{tot} derates linearly with 3.2 mW/K above 71 °C.

For SOT1202 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.

9. Recommended operating conditions

Table 7. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	V _{CC}	V
		Power-down mode; V _{CC} = 0 V	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C

10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	-40 °C to +85 °C			-40 °C to +125 °C		
			Min	Typ[1]	Мах	Min	Мах		
V _{OL}	LOW-level	V _I = V _{CC} or GND							
	output voltage	I _O = 100 μA; V _{CC} = 1.65 V to 5.5 V	-	-	0.1	-	0.1	V	
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.7	V	
		I _O = 8 mA; V _{CC} = 2.3 V	-	-	0.3	-	0.45	V	
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.4	-	0.6	V	
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.55	-	0.8	V	
		I _O = 32 mA; V _{CC} = 4.5 V	-	-	0.55	-	0.8	V	
V _{OH}	HIGH-level output voltage	V _I = V _{CC} or GND							
		I _O = -100 μA; V _{CC} = 1.65 V to 5.5 V	V _{CC} - 0.1	-	-	V _{CC} - 0.1	-	V	
		I _O = -4 mA; V _{CC} = 1.65 V	1.2	-	-	0.95	-	V	
		I _O = -8 mA; V _{CC} = 2.3 V	1.9	-	-	1.7	-	V	
		I _O = -12 mA; V _{CC} = 2.7 V	2.2	-	-	1.9	-	V	
		I _O = -24 mA; V _{CC} = 3.0 V	2.3	-	-	2.0	-	V	
		I _O = -32 mA; V _{CC} = 4.5 V	3.8	-	-	3.4	-	V	
lı	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	±0.1	±1	-	±1	μA	
I _{OFF}	power-off leakage current	$V_{I} \text{ or } V_{O} = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	±0.1	±2	-	±2	μA	
I _{CC}	supply current	V _I = 5.5 V or GND; I _O = 0 A; V _{CC} = 1.65 V to 5.5 V	-	0.1	4	-	4	μA	
ΔI _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A;$ $V_{CC} = 2.3 V to 5.5 V$	-	5	500	-	500	μA	
CI	input capacitance		-	2.5	-	-	-	pF	

[1] Typical values are measured at maximum V_{CC} and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 13.

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to	Unit		
			Min	Typ[1]	Max	Min	Мах	
t _{pd}	propagation delay	A, B, C to Y; see <u>Fig. 12</u> [2]						
		V _{CC} = 1.65 V to 1.95 V	1.0	6.0	14.4	1.0	18.0	ns
		V _{CC} = 2.3 V to 2.7 V	0.5	3.5	8.3	0.5	10.4	ns
		V _{CC} = 2.7 V	0.5	4.2	8.5	0.5	10.6	ns
		V _{CC} = 3.0 V to 3.6 V	0.5	3.8	6.3	0.5	7.9	ns
		V _{CC} = 4.5 V to 5.5 V	0.5	3.0	5.1	0.5	6.4	ns
C _{PD}	power dissipation capacitance	$V_{CC} = 3.3 \text{ V}; V_1 = \text{GND to } V_{CC}$ [3]	-	20	-	-	-	pF

[1] Typical values are measured at nominal V_{CC} and at T_{amb} = 25 °C.

[2]

 t_{pd} is the same as t_{PLH} and t_{PHL} C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: [3]

 f_i = input frequency in MHz;

 $f_o = output$ frequency in MHz;

 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

11.1. Waveform and test circuit

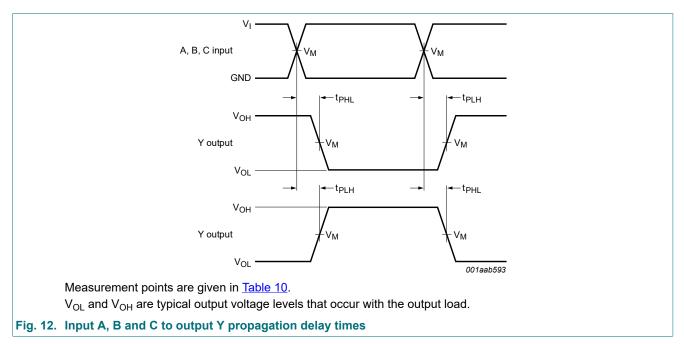
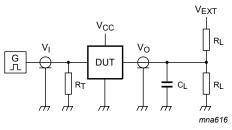


Table 10. Measurement points

Supply voltage	Input	Input	
V _{cc}	V _M	VI	V _M
1.65 V to 1.95 V	0.5V _{CC}	V _{CC}	0.5V _{CC}
2.3 V to 2.7 V	0.5V _{CC}	V _{CC}	0.5V _{CC}
2.7 V	1.5 V	2.7 V	1.5 V
3.0 V to 3.6 V	1.5 V	2.7 V	1.5 V
4.5 V to 5.5 V	0.5V _{CC}	V _{CC}	0.5V _{CC}



Measurement points are given in <u>Table 11</u>.

Definitions test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig. 13. Test circuit for measuring switching times

Table 11. Measurement points

Supply voltage	Input		Load	Load		
V _{cc}	VI	t _r = t _f	CL	RL	t _{PLH} , t _{PHL}	
1.65 V to 1.95 V	V _{CC}	≤ 2.0 ns	30 pF	1 kΩ	open	
2.3 to 2.7 V	V _{CC}	≤ 2.0 ns	30 pF	500 Ω	open	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	open	

12. Transfer characteristics

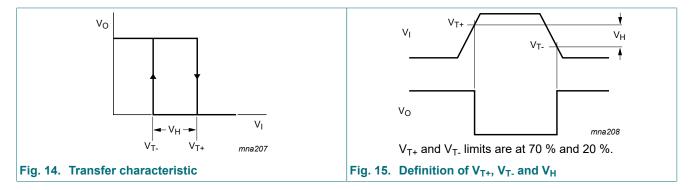
Table 12. Transfer characteristics

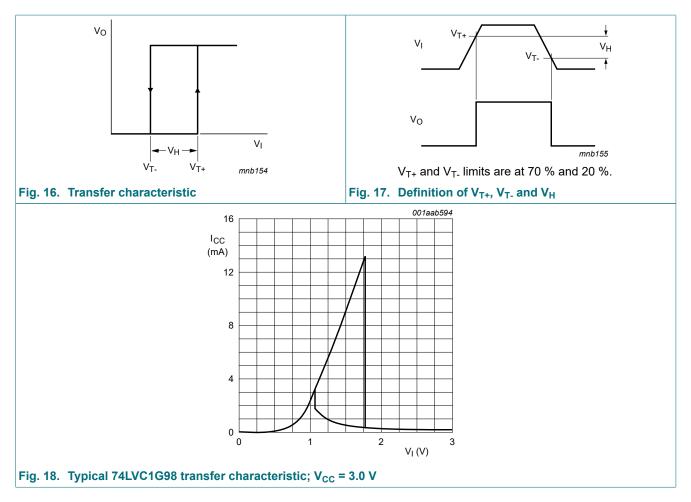
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-4	-40 °C to +85 °C			-40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max		
V _{T+}	positive-going threshold voltage	see <u>Fig. 14, Fig. 15, Fig. 16</u> and <u>Fig. 17</u>							
		V _{CC} = 1.8 V	0.70	1.02	1.20	0.67	1.20	V	
		V _{CC} = 2.3 V	1.11	1.42	1.60	1.08	1.60	V	
		V _{CC} = 3.0 V	1.50	1.79	2.00	1.47	2.00	V	
		V _{CC} = 4.5 V	2.16	2.52	2.74	2.13	2.74	V	
		V _{CC} = 5.5 V	2.61	2.99	3.33	2.58	3.33	V	
V _{T-}	negative-going threshold voltage	see <u>Fig. 14, Fig. 15, Fig. 16</u> and <u>Fig. 17</u>							
		V _{CC} = 1.8 V	0.30	0.53	0.72	0.30	0.75	V	
		V _{CC} = 2.3 V	0.58	0.77	1.00	0.58	1.03	V	
		V _{CC} = 3.0 V	0.80	1.04	1.30	0.80	1.33	V	
		V _{CC} = 4.5 V	1.21	1.55	1.90	1.21	1.93	V	
		V _{CC} = 5.5 V	1.45	1.86	2.29	1.45	2.32	V	
V _H	hysteresis voltage	(V _{T+} - V _{T-}); see <u>Fig. 14,</u> <u>Fig. 15, Fig. 16</u> and <u>Fig. 17</u>							
		V _{CC} = 1.8 V	0.30	0.48	0.62	0.23	0.62	V	
		V _{CC} = 2.3 V	0.40	0.64	0.80	0.34	0.80	V	
		V _{CC} = 3.0 V	0.50	0.75	1.00	0.44	1.00	V	
		V _{CC} = 4.5 V	0.71	0.97	1.20	0.65	1.20	V	
		V _{CC} = 5.5 V	0.71	1.13	1.40	0.65	1.40	V	

[1] Typical values are measured at T_{amb} = 25 °C.

12.1. Waveforms transfer characteristics





13. Package outline

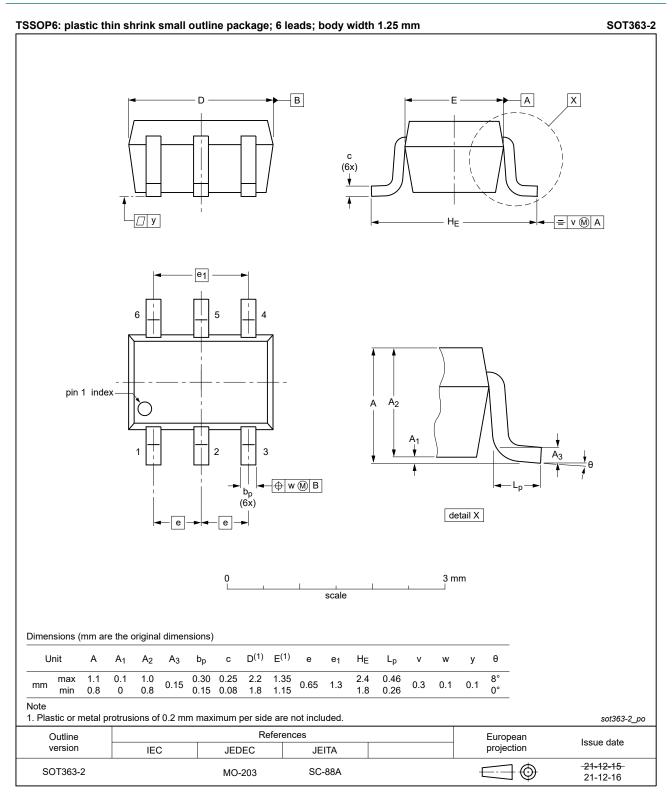


Fig. 19. Package outline SOT363-2 (TSSOP6)

74LVC1G98

Low-power configurable multiple function gate

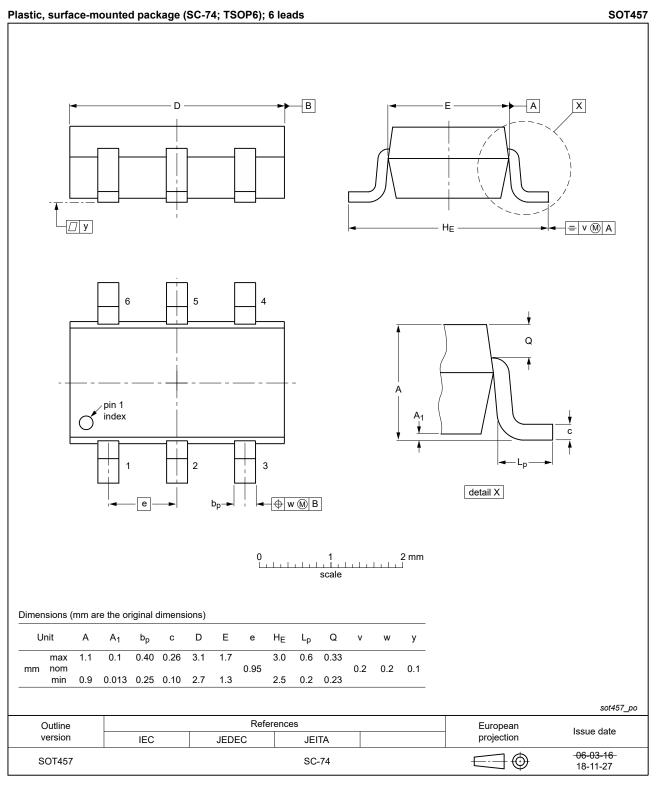


Fig. 20. Package outline SOT457 (SC-74; TSOP6)

74LVC1G98

Low-power configurable multiple function gate

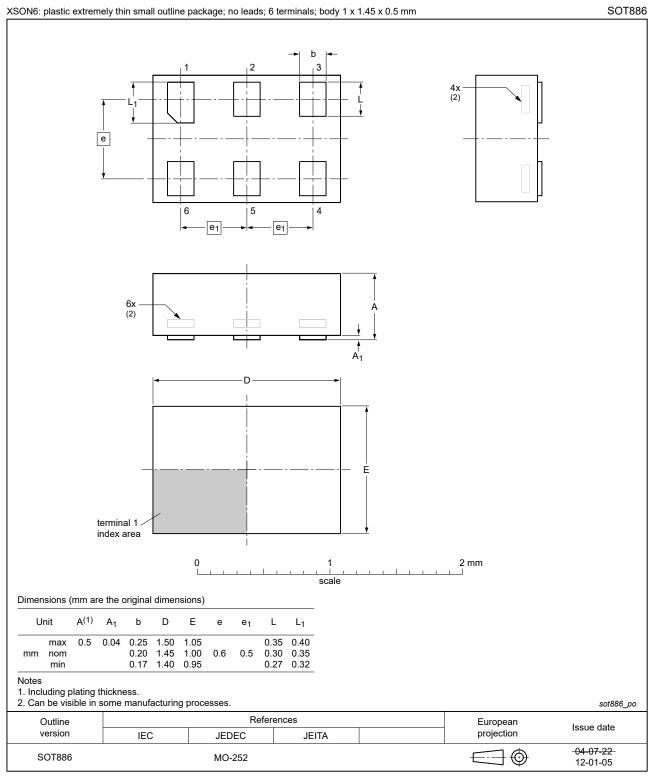
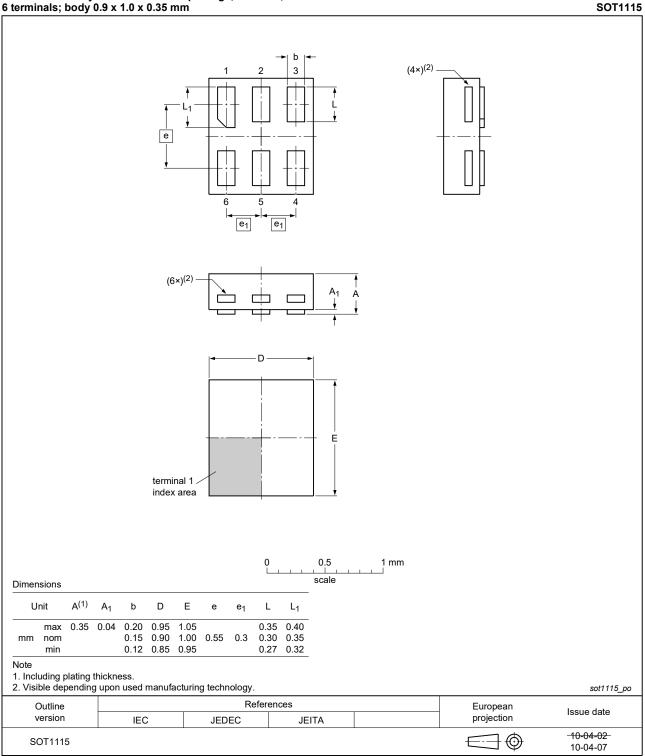


Fig. 21. Package outline SOT886 (XSON6)

XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm





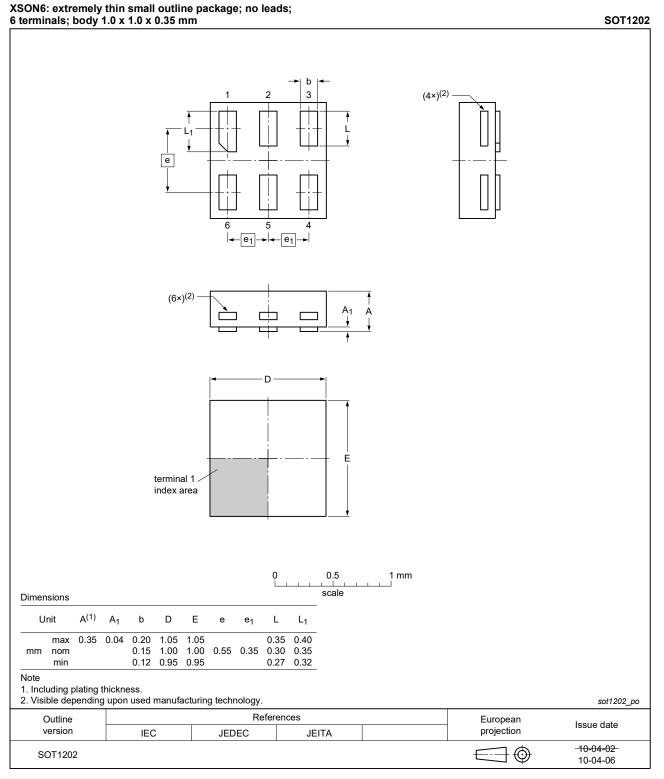


Fig. 23. Package outline SOT1202 (XSON6)

14. Abbreviations

Acronym	Description		
CDM	Charged Device Model		
CMOS	Complementary Metal Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
НВМ	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

15. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC1G98 v.6	20220125	Product data sheet	-	74LVC1G98 v.5		
Modifications:	Package S	Package SOT363 (SC-88) changed to SOT363-2 (TSSOP6).				
74LVC1G98 v.5	20210430	Product data sheet	-	74LVC1G98 v.4		
Modifications:	guidelines Legal texts Type numl <u>Section 8</u>: 	t of this data sheet has be of Nexperia. s have been adapted to the ber 74LVC1G98GF (SOT8 Derating values for P _{tot} to ackage outline drawing SC	e new company nar 91/XSON6) remove tal power dissipation	ne where appropriate. ed. n updated.		
74LVC1G98 v.4	20161219	Product data sheet	-	74LVC1G98 v.3		
Modifications:	• <u>Table 8</u> : The maximum limits for leakage current and supply current have changed.					
74LVC1G98 v.3	20111201	Product data sheet	-	74LVC1G98 v.2		
74LVC1G98 v.2	20111201	Product data sheet	-	74LVC1G98 v.1		
74LVC1G98 v.1	20101221	Product data sheet	-	-		

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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